

Application Data Sheet  
Application Information

Application type:: Regular  
Subject matter:: Utility  
CD-ROM or CD-R:: None  
Number of CD disks:: 0  
Number of copies of CDs:: 0  
Sequence submission?:: No  
Computer readable form (CRF) ?:: No  
Number of copies of CRF:: 0  
Title:: WAFER PACKAGING PROCESS OF  
PACKAGING LIGHT EMITTING DIODE  
Attorney docket number:: ITSUM3003/EM  
Request for early publication?:: No  
Request for non-publication?:: No  
Suggested drawing figure:: 9  
Total drawing sheets:: 9  
Small entity?:: YES

Applicant Information

Applicant authority type:: Inventor  
Primary citizenship country:: Taiwan, R.O.C.  
Status: Full capacity  
Given name:: Mei-Hung  
Middle name::  
Family name:: Hsu  
Name suffix:: n/a  
City of Residence:: Taipei City,  
State or province of residence:: n/a

Country of residence:: Taiwan, R.O.C.  
Street of mailing address:: 4F, No. 18, Alley 28, Lane 59, Sec.  
5, Nan Ching East Road.,  
City of mailing address:: Taipei City,  
State or province of mailing  
address:: n/a  
Country of mailing address:: Taiwan, R.O.C.  
Postal or zip code of mailing  
address:: n/a

Correspondence Information

Correspondence customer number:: 23364  
Phone number:: 703-683-0500  
Fax number:: 703-683-1080  
E-mail address:: mail@baonthomas.com

Representative Information

Representative customer number:: 23364

Assignee Information

Assignee name::  
Street of mailing address::  
City of mailing address::  
State or province of mailing  
address::  
Country of mailing address::  
Postal or zip code of mailing n/a  
address::